



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

**Akram et al.**

**Serial No.: 09/832,160**

**Filed: April 9, 2001**

**For: WAFER LEVEL PACKAGE AND  
METHODS OF FABRICATING**

**Examiner: D. Graybill**

**Group Art Unit: 2827**

**Attorney Docket No.: 2269-3846.2US  
(98-0796.02/US)**

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

March 18, 2004  
Date

Signature

Deidra Pfeil  
Name (Type/Print)

**AMENDMENT**

**Mail Stop NON-FEE AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**

**Sir:**

This Amendment is in response to the Office Action mailed on December 18, 2003, the initial period for response to which is set to expire on March 18, 2004.

**Amendments to the claims** are set forth in the listing of the claims, which begins on page 2 of this paper;

**Corrections to the drawings** are identified on page 7 of this paper, with an annotated sheet showing changes being enclosed herewith; and

**Remarks** start at page 8 of this paper.